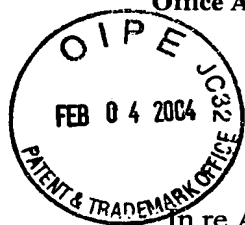


DOCKET NO.: TALW-0180
Application No.: 09/805,841
Office Action Dated: November 5, 2003

PATENT



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Toshiki Inoue and Kyoko Kumagai

Confirmation No.: **3801**

Application No.: **09/805,841**

Group Art Unit: **1742**

Filing Date: **March 14, 2001**

Examiner: **Wesley A. Nicolas**

For: **Electrolytic Plating Method and Device for a Wiring Board**

EXPRESS MAIL LABEL NO: EL969193322US
DATE OF DEPOSIT: February 4, 2004

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

REPLY PURSUANT TO 37 CFR § 1.111

In response to the Official Action dated **November 5, 2003**, reconsideration is respectfully requested in view of the amendments and/or remarks as indicated below:

- ☐ **Amendments to the Specification** begin on page _____ of this paper.
- ☒ **Amendments to the Claims** are reflected in the listing of the claims which begins on page 2 of this paper.
- ☐ **Amendments to the Drawings** begin on page _____ of this paper and include an attached replacement sheet.
- ☒ **Remarks/Arguments** begin on page 4 of this paper.